

# Preface

The aim of the 7<sup>th</sup> International Conference on Advanced Materials and Engineering Materials (ICAMEM2018, Bangkok, Thailand 17-18 May 2018) was to provide leading academics and industry scientists a platform to communicate recent advances in Advanced Materials Science, Engineering Materials Research and an opportunity to establish multilateral collaborations.

Since the first ICAMEM in Shenyang, China (2011), a series of ICAMEM has been held in Asia: the 2<sup>nd</sup>, Beijing and Shanghai, China (2012); the 3<sup>rd</sup>, Singapore (2013); the 4<sup>th</sup>, Ningbo and Hong Kong, China (2014); the 5<sup>th</sup>, Hong Kong (2016) and the 6<sup>th</sup>, Singapore.

The papers were selected after the peer-review process by conference committee members and international reviewers. The submitted papers were selected on the basis of originality, significance, and clarity for the purpose of the conference.

On behalf of the organizing committee, the editor would like to acknowledge the technical comments from the reviewers and thank all of the authors for their contributions to this proceeding book.

With our warmest regards,

Conference Organizing Chair  
Prof. Peng-Sheng Wei  
National Sun Yat-Sen University, Kaohsiung, Taiwan  
June 4, 2018

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